BYP 25A05 ... BYP 25K6



Silicon Press-Fit-Diodes

BYP 25A05...BYP 25K6 Forward Current: 25 A

Reverse Voltage: 50 to 600 V

Publish Data

Features

- max. solder temperature 260°C, max. 5s
- UL classification 94V-0
- Standard packaging: bulk

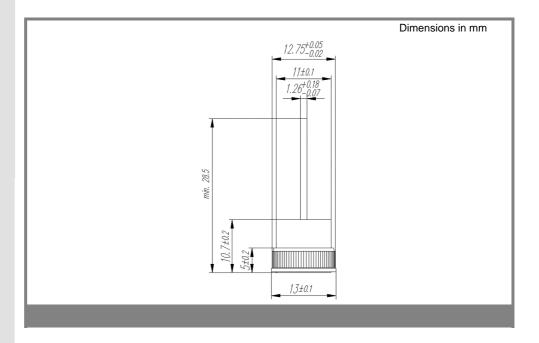
Mechanical Data

- Weight approx. 8 g
- Metal press-fit case with plastic cover
- Terminals: plated terminals solderable per IEC 68-2-20
- Mounting position : any

Туре	Wired to	Wired to	Repetitive	Surge	Maximum
			peak	peak	forward
	ANODE	CATHODE	reverse	reverse	voltage
			voltage	voltage	T _i = 25 °C
					I _F = 25 A
			V_{RRM}	V_{RSM}	V_{F}
			V	V	V
BYP 25	BYP 25A05	BYP 25K05	50	60	1,1
BYP 25	BYP 25A1	BYP 25K1	100	120	1,1
BYP 25	BYP 25A2	BYP 25K2	200	240	1,1
BYP 25	BYP 25A3	BYP 25K3	300	360	1,1
BYP 25	BYP 25A4	BYP 25K4	400	480	1,1
BYP 25	BYP 25A6	BYP 25K6	600	700	1,1

Absolute	Maximum Ratings $T_c = 25$	°C, unless otherwise specified	
Symbol	Conditions	Values	Units
I _{FAV}	Max. averaged fwd. current, R-load, T_c = 150 °C	25	Α
I _{FRM}	Repetitive peak forward current f > 15 Hz ¹⁾	90	Α
I _{FSM}	Peak fwd. surge current 50 Hz half sinus-wave	270	Α
I²t	Rating for fusing, t < 10 ms	375	A²s
R _{thA}	Thermal resistance junction to case	1	K/W
T _j	Operating junction temperature	- 50 + 215	°C
T _s	Storage temperature	- 50 + 215	°C

Characteristics		T_c = 25 °C, unless otherwise specified		
Symbol	Conditions	Values	Units	
I _R	Maximum leakage current, T _A 25 °C; V _R = V _{RRM}	100	μA	



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